

-40V P-Channel Enhancement Mode MOSFET

Description

The AP40P04D uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

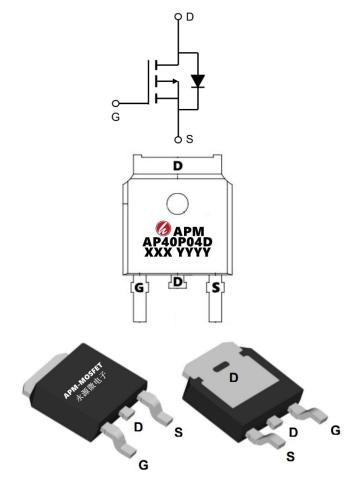
V_{DS} = -40V I_D =-40 A

 $R_{DS(ON)} < 18m\Omega @ V_{GS}=-10V (Type: 15m\Omega)$

Application

Battery protection

Load switch Uninterruptible power supply



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP40P04D	TO-252-3L	AP40P04D XXX YYYY	2500

Absolute Maximum Ratings (TC=25 °C unless otherwise noted)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	-40	V
Vgs	Gate-Source Voltage	±20	V
I₀@Tc=25°C	Continuous Drain Current, V _{GS} @ -10V ¹	-40	А
I₀@Tc=100°C	Continuous Drain Current, V _{GS} @ -10V ¹	-23	А
Ідм	Pulsed Drain Current ²	-120	А
EAS	Single Pulse Avalanche Energy ³	125	mJ
P₀@Tc=25°C	Total Power Dissipation ⁴	25	W
P _D @T _A =25°C	Total Power Dissipation ⁴	16	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R ₀ JA	Thermal Resistance Junction-Ambient ¹	62	°C/W
Rejc	Thermal Resistance Junction-Case ¹ 5		°C/W

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Electrical Characteristics (TJ=25°C, unless otherwise noted)

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	V_{GS} =0V , I _D =-250uA	-40	-44		V	
$\triangle BV$ DSS/ $\triangle T_J$	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =-1mA		-0.023		V/°C	
	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-30A		15	18	mΩ	
Rds(on)		V _{GS} =-4.5V , I _D =-20A		18	25		
VGS(th)	Gate Threshold Voltage		-1.0	-1.6	-2.5	V	
$\bigtriangleup V_{\text{GS(th)}}$	V _{GS(th)} Temperature Coefficient	V _{GS} =V _{DS} , I _D =-250uA		4.74		mV/°C	
1	Ducin Course Lookana Current	V_{DS} =-40V , V_{GS} =0V , T_J =25°C			1	۵	
IDSS	Drain-Source Leakage Current	V _{DS} =-40V , V _{GS} =0V , T _J =55°C			5	uA	
Igss	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA	
Qg	Total Gate Charge (-4.5V)			25		nC	
Qgs	Gate-Source Charge	V _{DS} =-20V , V _{GS} =-4.5V , I _D =-12A		11			
Qgd	Gate-Drain Charge			9.5			
Td(on)	Turn-On Delay Time			48		ns	
Tr	Rise Time	VDD =-15V, RL=15Ω		24			
Td(off)	Turn-Off Delay Time	ID =-1A, VGEN =-10V, RG =6Ω		88			
T _f	Fall Time			9.6			
Ciss	Input Capacitance			2760			
Coss	Output Capacitance	V _{DS} =-20V , V _{GS} =0V , f=1MHz		260		pF	
Crss	Reverse Transfer Capacitance			85			
ls	Continuous Source Current ^{1,5}				-40	А	
lsм	Pulsed Source Current ^{2,5}	$V_G=V_D=0V$, Force Current			-90	А	
Vsd	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25℃			-1.3	V	

Note :

1、The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.

2、The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3、The EAS data shows Max. rating . The test condition is VDD=-32V,VGS=-10V,L=0.1mH,IAS=-30A

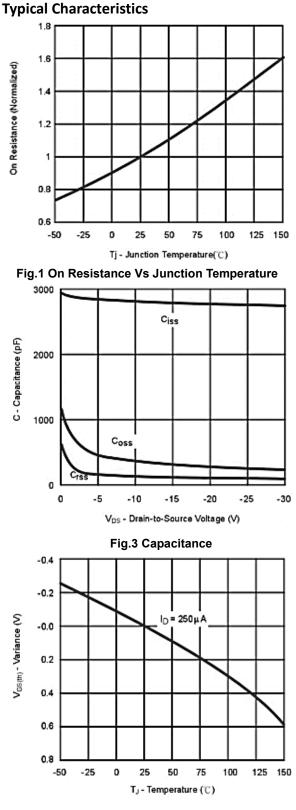
 $4\,{\scriptstyle \sim}\,$ The power dissipation is limited by 150 $^\circ\!{\rm C}$ junction temperature

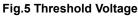
5. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.

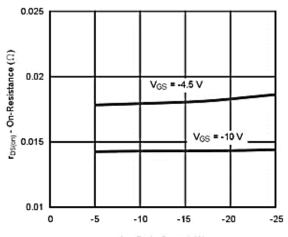
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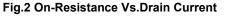
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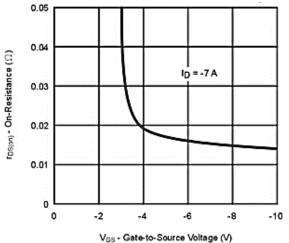




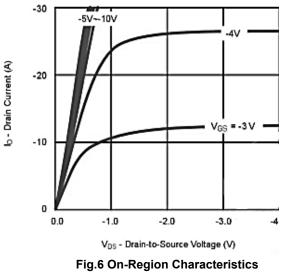


I_D - Drain Current (A)









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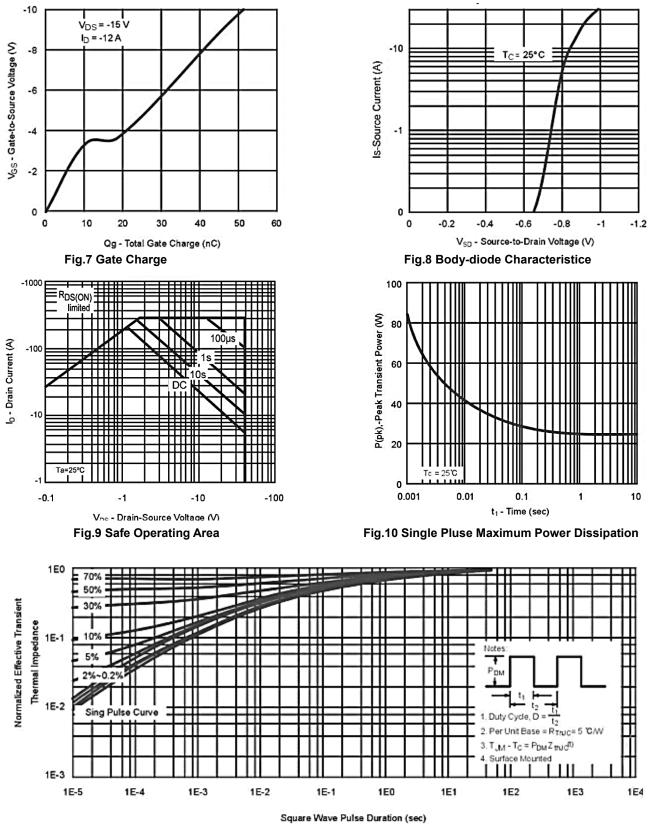
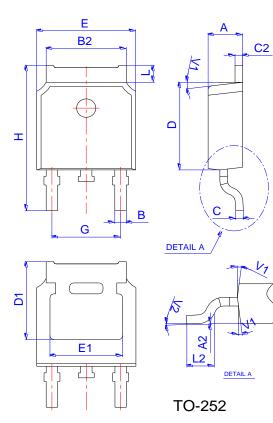


Fig.11 Normalized Maximum Transient Thermal Impedance



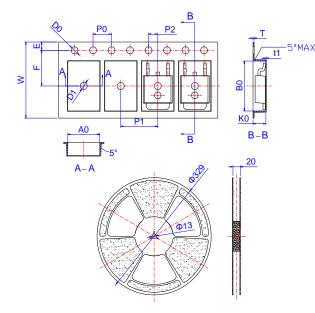
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Package Mechanical Data:TO-252-3L



	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
В	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
С	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
Н	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Spectification-TO-252



	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
Т	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583

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Edition	Date	Change
Rve1.0	2021/8/8	Initial release

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